

## **Application Data Sheet**

### **Application Information**

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	METHODS AND APPARATUS FOR ACHIEVING THERMAL MANAGEMENT USING PROCESSOR MANIPULATION
Attorney Docket Number::	SCEI 3.0-200
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	9A
Total Drawing Sheets::	12
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

### **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Keisuke
Family Name::	Inoue
City of Residence::	Tokyo
Country of Residence::	Japan
Street of mailing address::	c/o Sony Computer Entertainment Inc. 2-6-21, Minami-Aoyama; Minato-ku
City of mailing address::	Tokyo

Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 107-0062

**Correspondence Information**

Correspondence Customer Number:: 000530

**Representative Information**

Representative Customer Number:: 000530

**Assignee Information**

Assignee name:: Sony Computer Entertainment Inc.  
Street of mailing address:: 2-6-21, Minami-Aoyama  
Minato-ku  
City of mailing address:: Tokyo  
Country of mailing address:: Japan  
Postal or Zip Code of mailing address:: 107-0062